

L Number	Hits	Search Text	DB	Time stamp
1	27560	substrate with (conductive or metal or conducting) with glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/09 08:37
2	448	(substrate with (conductive or metal or conducting) with glass) and anodi\$6 and TFT\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/09 08:38
-	8901	anodized near3 alumin\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 13:07
-	7211	anodized near alumin\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 12:49
-	474	(anodized near3 alumin\$6) and (nano\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 12:51
-	2883	(anodized near3 alumin\$6) and ((conductor\$1 or conductive or electroconductor\$1 or electroconductive or metal\$1) with (layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 13:35
-	2279	(anodized near3 alumin\$6) and (filling or filled)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 15:05
-	177	(anodized near3 alumin\$6) and ((pore\$1 or hole\$1 or nano\$6) with (filling or filled))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 13:08
-	9	("3850762" "4687551" "4737799" "5077114" "5089092" "5259957" "5811917" "5866975" "5975976").PN.	USPAT	2002/09/08 13:33
-	289	(anodized near3 alumin\$6) and ((conductor\$1 or conductive or electroconductor\$1 or electroconductive or metal\$1) with (patterned))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 13:44
-	112	(anodized near3 alumin\$6) and ((electrode\$1) with (patterned))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 13:49
-	227	(anodized near3 alumin\$6) and ((connect\$4 with fill\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 14:10
-	45	(anodized near3 alumin\$6) and (selectively with (filling or filled))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 15:08
-	0	EP adj 0951047\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 15:09

	0	EP0951047\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 15:09
	85	EP951047\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 15:11
	2	EP adj 951047\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 15:11
	5	"6278231"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 15:14
	9	("3850762" "4687551" "4737799" "5077114" "5089092" "5259957" "5811917" "5866975" "5975976").PN.	USPAT	2002/09/08 15:14
	10	("5064464" "5194128" "5219804" "5407458" "5447708" "5486675" "5788738" "5866975" "6266459" "6278231").PN.	USPAT	2002/09/08 15:17
	177	quantum and pores and anodi\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:02
	4	("5641591" "5696386" "5904509" "5962872").PN.	USPAT	2002/09/08 15:46
	0	6214738.URPN.	USPAT	2002/09/08 15:47
	11	(GMR or (spin adj valve\$1)) and pores and anodi\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:10
	7	("5237529" "5477482" "5774394" "5902690" "5956267" "5991193" "6016269").PN.	USPAT	2002/09/08 16:08
	923	(365/158. 129, 171, 159, "173").ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:12
	6	((365/158. 129, 171, 159, "173").ccls.) and anodi\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:12
	3	((365/158. 129, 171, 159, "173").ccls.) and pore\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:12
	588	(205/121, 105, 173, 174, 202, "207").ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/09/08 16:13
	107	((205/121, 105, 173, 174, 202, "207").ccls.) and substrate\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 16:37

-	1974	(438/3, 108, 381, 399, 408, 409, "667").ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:32
-	153	((438/3, 108, 381, 399, 408, 409, "667").ccls.) and anodi\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 16:38
-	2698	(257/3, 9, 14, 13, 28, 531, "778").ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:32
-	59	((257/3, 9, 14, 13, 28, 531, "778").ccls.) and anodi\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:35
-	2386	anodi\$6 and nano\$8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:36
-	212	anodi\$6 and (nano\$1structure\$12 or nano\$1scale or nano\$1pore\$1 or nano\$1hole\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:39
-	5463	anodi\$6 and (magnetic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:40
-	2900	(anodi\$6 and (magnetic)) and (porous or pore\$1 or hole\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:42
-	1561	((anodi\$6 and (magnetic)) and (porous or pore\$1 or hole\$1)) and fill\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:42
-	3538	(anodi\$6 and (magnetic)) and (fill\$4 woth (porous or pore\$1 or hole\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:44
-	523	(anodi\$6 and (magnetic)) and (fill\$4 with (porous or pore\$1 or hole\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/09/08 17:44